

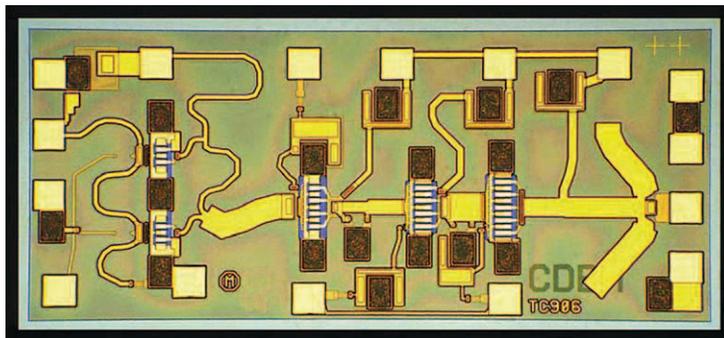
Keysight Technologies

HMMC-5040

20–40 GHz Amplifier

1GG6-4066

Data Sheet

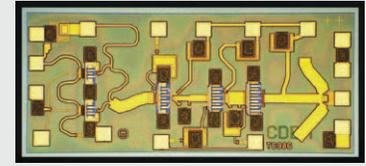


Features

- Large bandwidth:
20 to 44 GHz typical
21 to 40 GHz specified
- High gain: 22 dB typical
- Saturated output power:
21 dB typical
- Supply bias:
 ≤ 4.5 volts @ ≤ 300 mA

Description

The Keysight Technologies, Inc. HMMC-5040 is a high-gain broad-band MMIC amplifier designed for both military applications and commercial communication systems. This four stage amplifier has input and output matching circuitry for use in 50 ohm environments. It is fabricated using a PHEMT integrated circuit structure that provides exceptional broadband performance. The backside of the chip is both RF and DC ground. This helps simplify the assembly process and reduces assembly related performance variations and costs. This MMIC is a cost effective alternative to hybrid (discrete-FET) amplifiers that require complex tuning and assembly processes.



Chip size:
1720 x 760 μm (67.7 x 29.9 mils)
Chip size tolerance:
 $\pm 10 \mu\text{m}$ (± 0.4 mils)
Chip thickness:
 $127 \pm 15 \mu\text{m}$ (5 ± 0.6 mils)
Pad dimensions:
 $80 \times 80 \mu\text{m}$ (3.1 x 3.1 mils)

Absolute Maximum Ratings¹

Symbol	Parameters/conditions	Min	Max	Units
$V_{1,2-3-4}$	Drain supply voltages		5	volts
$V_{G1,2,3-4}$	Gate supply voltages	-3.0	0.5	volts
I_{DD}	Total drain current		400	mA
P_{in}	RF input power		21	dBm
T_{ch}	Channel temperature ²		160	$^{\circ}\text{C}$
T_A	Backside Ambient Temperature	-55	+75	$^{\circ}\text{C}$
T_{st}	Storage Temperature	-65	+165	$^{\circ}\text{C}$
T_{max}	Maximum Assembly Temperature		300	$^{\circ}\text{C}$

1. Absolute maximum ratings for continuous operation unless otherwise noted.
2. Refer to DC specifications/physical properties table for derating information.

DC Specifications/Physical Properties¹

Symbol	Parameters/conditions	Min.	Typ.	Max	Units
$V_{D1,2-3-4}$	Drain supply operating voltages	20	5.0	5	Volts
I_{D1}	First stage drain supply current ($V_{DD} = 4.5 \text{ V}$, $V_{G1} \sim -0.6 \text{ V}$)		55		mA
I_{D2-3-4}	Total drain supply current for stage ($V_{DD} = 4.5 \text{ V}$, $V_{GG} \sim -0.6 \text{ V}$)		245		mA
$V_{G1,2,3-4}$	Gate supply operating voltages ($I_{DD} \sim 300 \text{ mA}$)		-0.6		
V_P	Pinch-off voltage ($V_{DD} = 4.5 \text{ V}$, $I_{DD} \leq 10 \text{ mA}$)	-2	-1.2	-0.8	Volts
θ_{ch-bs}	Thermal resistance ² (channel-to-backside at $T_{ch} = 160^{\circ}\text{C}$)		62		$^{\circ}\text{C}/\text{Watt}$
T_{ch}	Channel temperature ³ ($T_A = 75^{\circ}\text{C}$, MTTF > 106 hrs, $V_{DD} = 4.5 \text{ V}$, $I_{DD} = 300 \text{ mA}$)		160		$^{\circ}\text{C}$

1. Backside ambient operating temperature $T_A = 25^{\circ}\text{C}$ unless otherwise noted.
2. Thermal resistance ($^{\circ}\text{C}/\text{Watt}$) at a channel temperature T ($^{\circ}\text{C}$) can be estimated using the equation: $\theta(T) \sim 62 \cdot \frac{T - 273}{160 - 273}$
3. Derate MTTF by a factor of two for every 8°C above T_{ch} .

RF Specifications

($T_A = 25^\circ\text{C}$, $Z_0 = 50\ \Omega$, $V_{DD} = 4.5\ \text{V}$, $I_{DD} = 300\ \text{mA}$)

Symbol	Parameters/conditions	Broadband specifications			Narrow band performance			Units
		Min.	Typ.	Max.	Typical			
BW	Operating bandwidth	21	20-44	40	21-24	27-29	37-40	GHz
Gain	Small signal gain	20	22		25	23	22	dB
Δ Gain	Small signal gain flatness		± 1.5		± 1	± 0.75	± 0.3	dB
$(RL_{in})_{MIN}$	Minimum input return loss	8	10		9	10	14	dB
$(RL_{out})_{MIN}$	Minimum output return loss	8	10		10	11	12	dB
Isolation	Reverse isolation		54		54	54	54	dB
$P_{-1\ \text{dB}}$	Output power at 1 dB gain compression		18		18	18	18	dBm
P_{SAT}	Saturated output power at 3 dB compression	20	21		21	21	21	dBm

Applications

The HMMC-5040 broadband amplifier is designed for both military (35 GHz) applications and wireless communication systems that operate at 23, 28, and 38 GHz. It is also suitable for use as a frequency multiplier due to excellent below-band input return loss and high gain.

Biassing and Operation

The recommended DC bias condition is with all drains connected to single 4.5 volt supply and all gates connected to an adjustable negative voltage supply as shown in Figure 12. The gate voltage is adjusted for a total drain supply current of typically up to 300 mA. Figures 4, 5, 8, and 9 can be used to help estimate the minimum drain voltage and current necessary for a given RF gain and output power.

The second, third, and fourth stage DC drain bias lines are connected internally (Figure 1) and therefore require only a single bond wire. An additional bond wire is needed for the first stage DC drain bias, VD1.

Only the third and fourth stage DC gate bias lines are connected internally. A total of three DC gate bond wires are required: one for VG1, one for VG2, and one for the VG3-to-VG4 connection.

The RF input has matching circuitry that creates a 50 ohm DC and RF path to ground. A DC blocking capacitor should be used in the RF input transmission line. Any DC voltage applied to the RF input must be maintained below 1 volt. The RF output is AC-coupled.

No ground wires are needed since ground connections are made with plated through-holes to the backside of the device.

The HMMC-5040 can also be used to double, triple, or quadruple the frequency of input signals. Many bias schemes may be used to generate and amplify desired harmonics within the device. The information given here is intended to be used by the customer as a starting point for such applications. Optimum conversion efficiency is obtained with approximately 14 dBm input drive level.

As a doubler, the device can multiply an input signal in the 10 to 20 GHz frequency range up to 20 to 40 GHz with conversion gain for output frequencies exceeding 30 GHz. Similarly, 5 to 10 GHz signals can be quadrupled to 20 to 40 GHz with some conversion loss. Frequency doubling or quadrupling is accomplished by operating the first gain stage at pinch-off ($V_{G1} = V_P \approx 1.2$ volts). Stages 2, 3, and 4 are biased for normal amplification. The assembly diagram shown in Figure 13 can be used.

To operate the device as a frequency tripler the drain voltage can be reduced to approximately 2.5 volts and the gate voltage can be set at about -0.4 volts or adjusted to minimize second harmonics if needed. Either of Figures 12 and 13 can be used.

Contact your local Keysight Technologies, INC. sales representative for additional information concerning multiplier performance and operating conditions.

Assembly Techniques

It is recommended that the RF input and output connections be made using either 500 lines/inch (or equivalent) gold wire mesh. The RF connections should be kept as short as possible to minimize inductance. The DC bias supply wires can be 0.7 mil diameter gold.

GaAs MMICs are ESD sensitive. ESD preventive measures must be employed in all aspects of storage, handling, and assembly.

MMIC ESD precautions, handling considerations, die attach and bonding methods are critical factors in successful GaAs MMIC performance and reliability.

Keysight application note, “GaAs MMIC ESD, Die Attach and Bonding Guidelines” (literature #5991-3484EN) provides basic information on these subjects.

Additional references

Keysight application note, “HMMC-5040 20–40 GHz Amplifier” (5991-3564EN)

Keysight application note, “HMMC-5040 As a 20–40 GHz Multiplier” (5991-3565EN)

Keysight product note, “HMMC-5040 and HMMC-5032 Demo, 20–32 GHz High Gain Medium Power Amp.” (5991-3571EN)

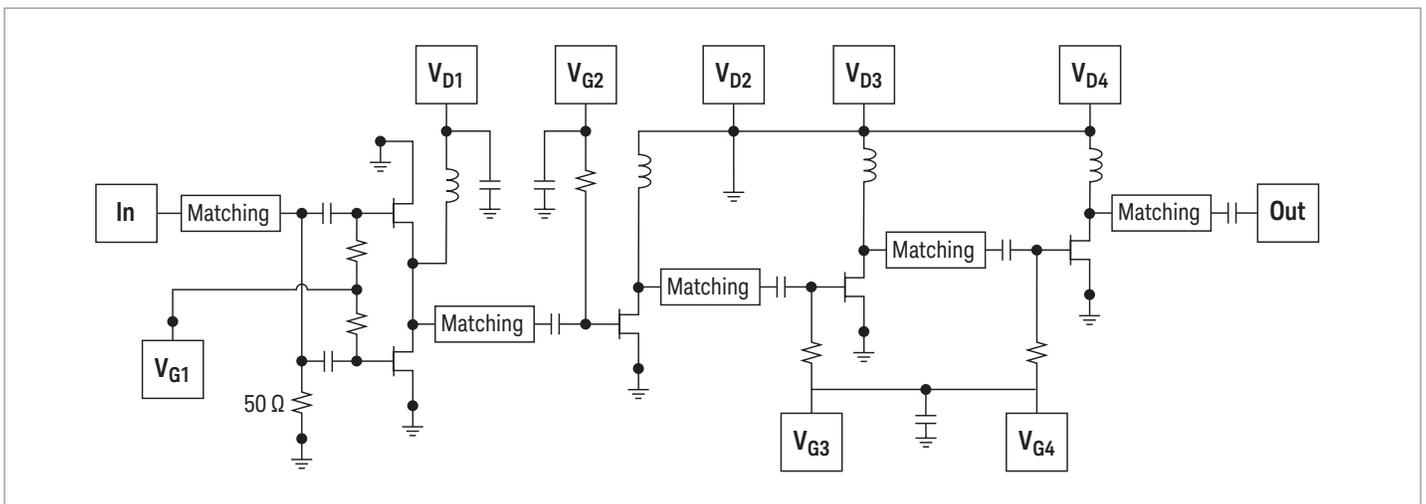


Figure 1. Simplified schematic diagram

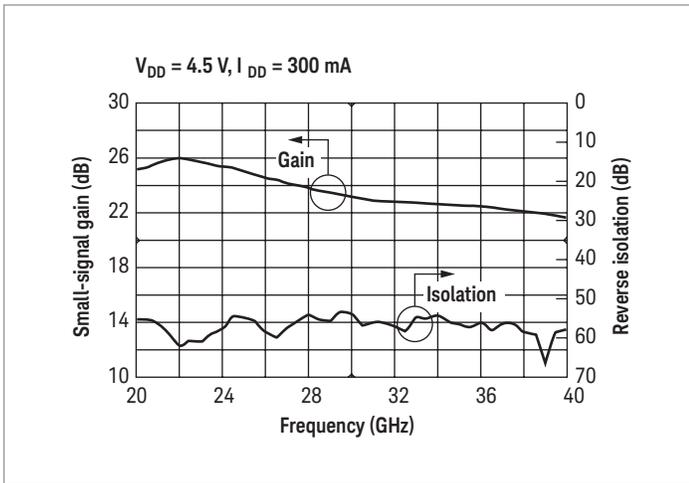


Figure 2. Typical gain and isolation vs. frequency¹

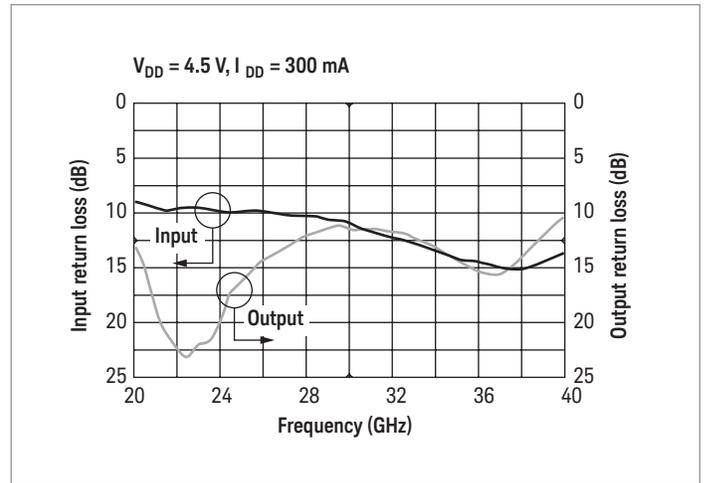


Figure 3. Typical input and output return loss vs. frequency¹

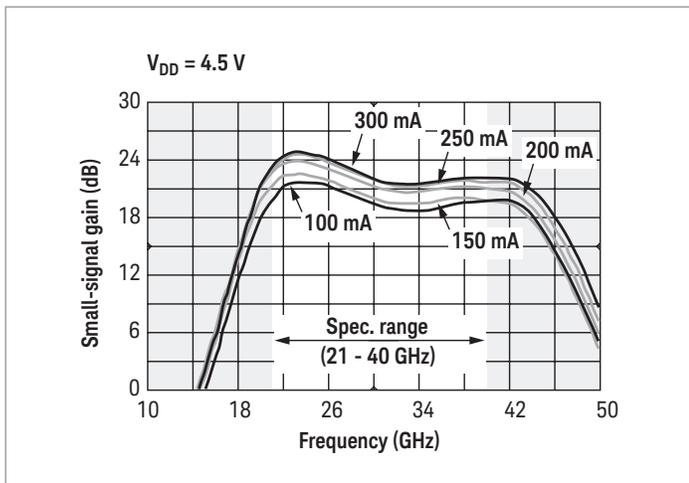


Figure 4. Broadband gain as a function of drain current vs. frequency with $V_{DD} = 4.5\text{ V}$ ¹

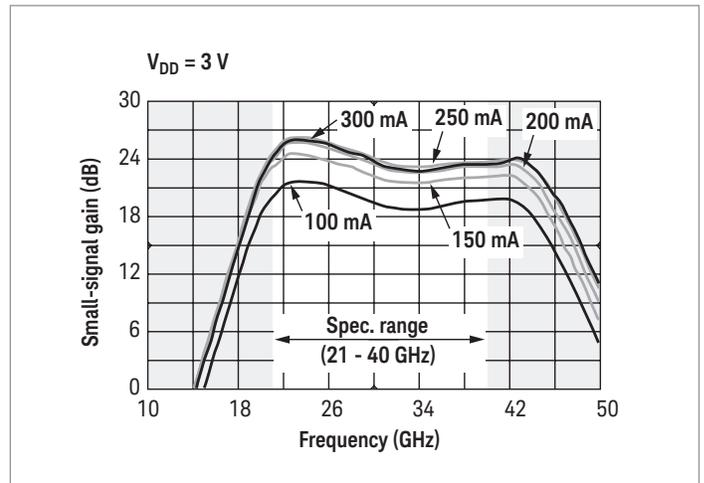


Figure 5. Broadband gain as a function of drain current vs. frequency with $V_{DD} = 3\text{ V}$ ¹

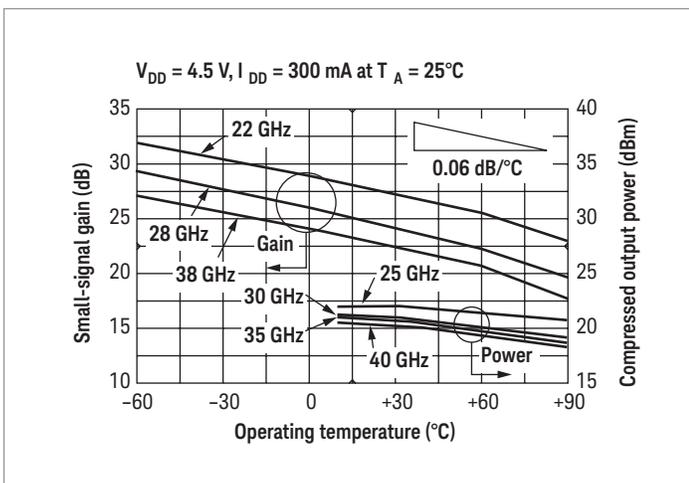


Figure 6. Small-signal gain¹ and compressed power² vs. temperature

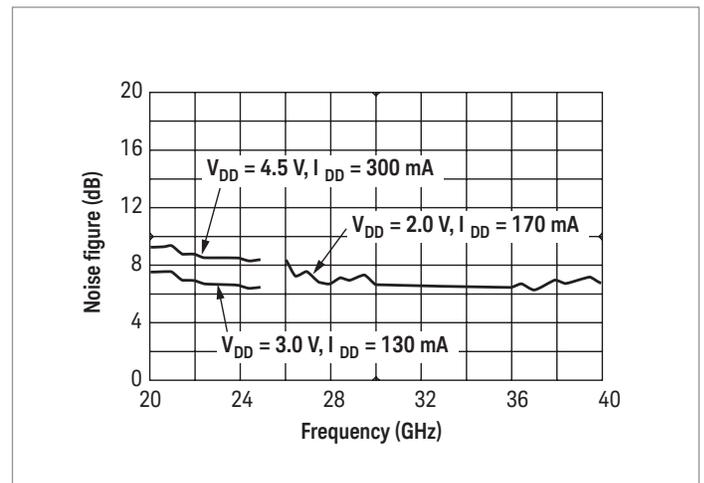


Figure 7. Noise figure vs. frequency

1. Measurements taken on a device mounted in a connectorized package calibrated at the connector terminals
 2. Output power into 50 ohms with 2 dBm input power

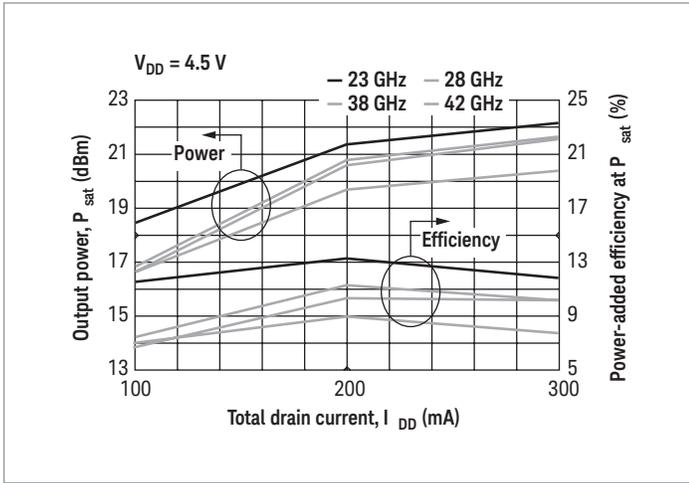


Figure 8. Output power¹ and efficiency vs. drain current with V_{DD} = 4.5 V

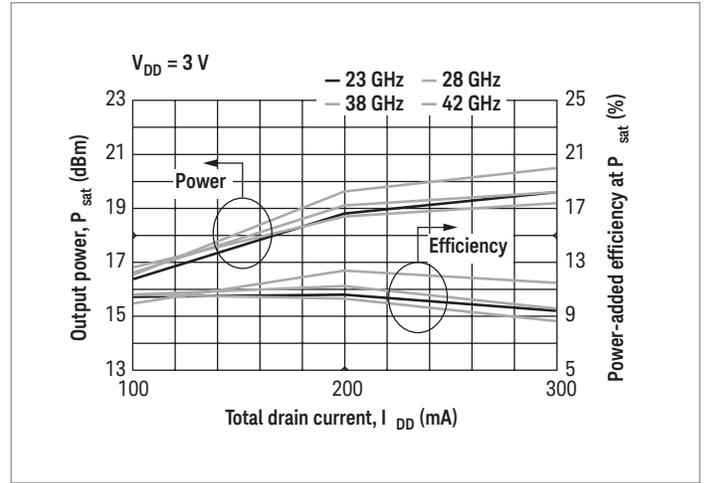


Figure 9. Output power¹ and efficiency vs. drain current with V_{DD} = 3 V

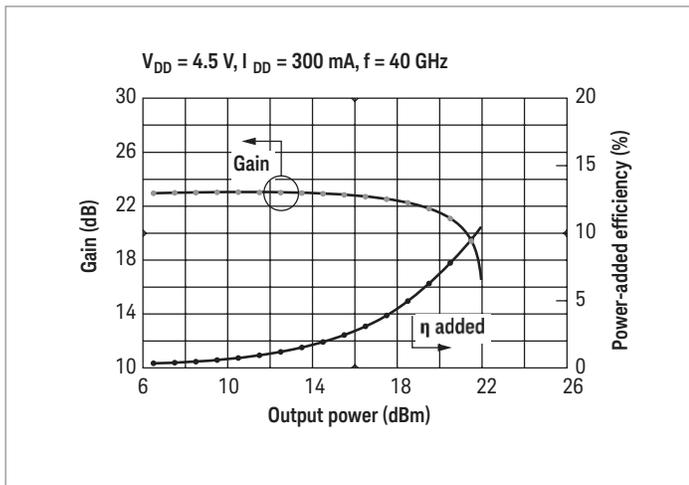


Figure 10. Gain compression and efficiency characteristics²

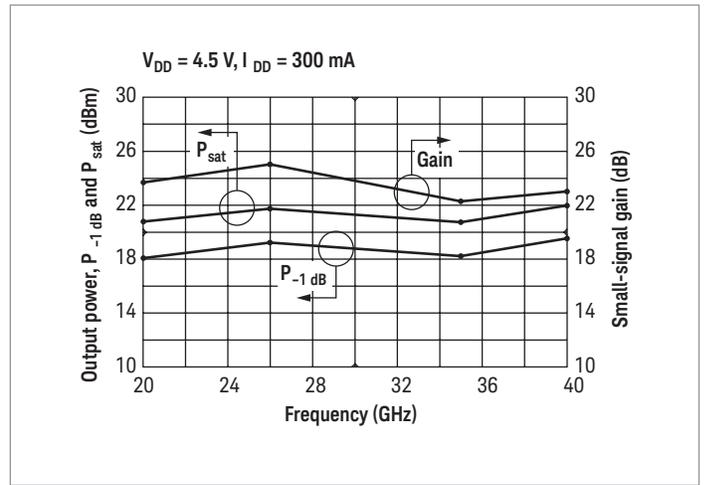


Figure 11. Output power and gain vs. frequency characteristics²

1. Output power into 50 ohms with 2 dBm input power
 2. Wafer-probed measurements

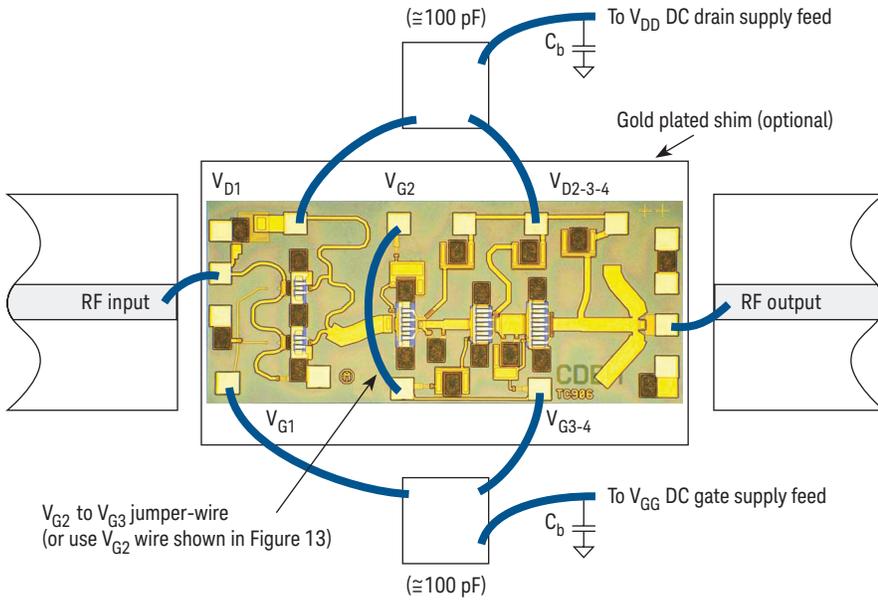
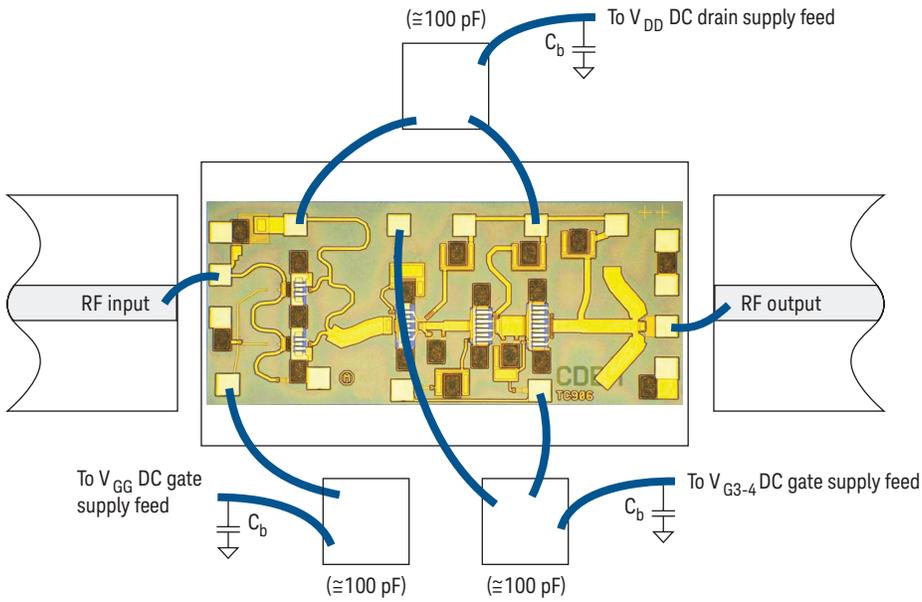


Figure 12. Single drain and single gate supply assembly for tripler and standard amplifier applications.



optional variation to the VG2 jumper-wire bonding scheme presented in Figure 12.

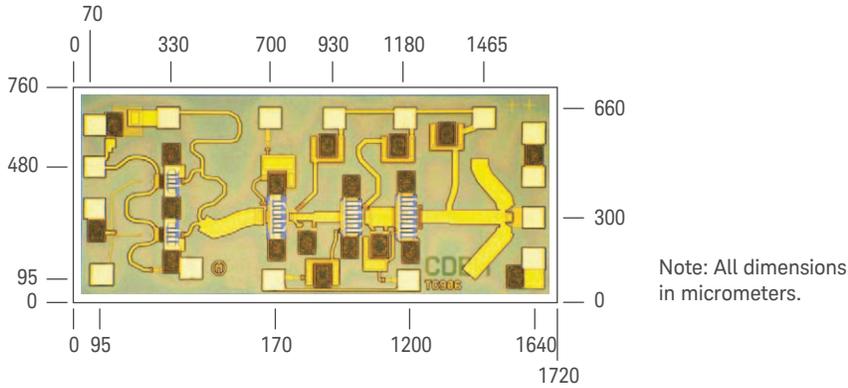


Figure 14. Bonding pad locations.

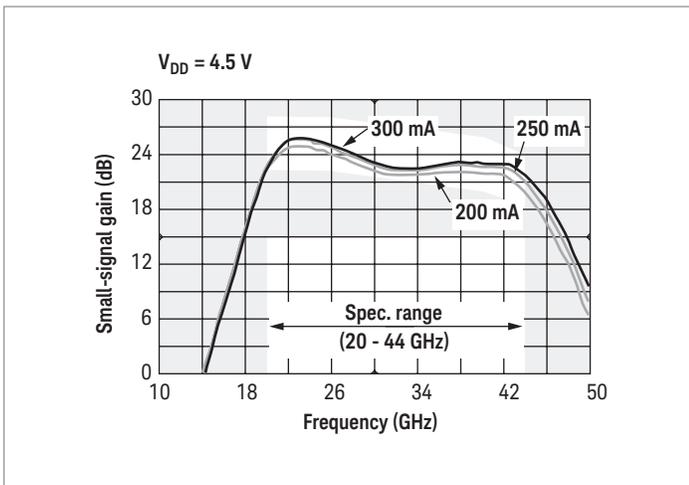


Figure 15. 1GG6-4066 broadband gain as a function of drain current vs. frequency with $V_{DD} = 4.5\text{ V}$

This data sheet contains a variety of typical and guaranteed performance data. The information supplied should not be interpreted as a complete list of circuit specifications. Customers considering the use of this, or other Keysight GaAs ICs, for their design should obtain the current production specifications from Keysight Technologies. In this data sheet the term typical refers to the 50th percentile performance. For additional information contact Keysight Technologies at MMIC_Helpline@keysight.com.

myKeysight

myKeysight

www.keysight.com/find/mykeysight

A personalized view into the information most relevant to you.

Three-Year Warranty

www.keysight.com/find/ThreeYearWarranty

Keysight's commitment to superior product quality and lower total cost of ownership. The only test and measurement company with three-year warranty standard on all instruments, worldwide.



Keysight Assurance Plans

www.keysight.com/find/AssurancePlans

Up to five years of protection and no budgetary surprises to ensure your instruments are operating to specification so you can rely on accurate measurements.



www.keysight.com/quality

Keysight Technologies, Inc.

DEKRA Certified ISO 9001:2008

Quality Management System



Keysight Channel Partners

www.keysight.com/find/channelpartners

Get the best of both worlds: Keysight's measurement expertise and product breadth, combined with channel partner convenience.

www.keysight.com/find/mmic

For more information on Keysight Technologies' products, applications or services, please contact your local Keysight office. The complete list is available at: www.keysight.com/find/contactus

Americas

Canada	(877) 894 4414
Brazil	55 11 3351 7010
Mexico	001 800 254 2440
United States	(800) 829 4444

Asia Pacific

Australia	1 800 629 485
China	800 810 0189
Hong Kong	800 938 693
India	1 800 112 929
Japan	0120 (421) 345
Korea	080 769 0800
Malaysia	1 800 888 848
Singapore	1 800 375 8100
Taiwan	0800 047 866
Other AP Countries	(65) 6375 8100

Europe & Middle East

Austria	0800 001122
Belgium	0800 58580
Finland	0800 523252
France	0805 980333
Germany	0800 6270999
Ireland	1800 832700
Israel	1 809 343051
Italy	800 599100
Luxembourg	+32 800 58580
Netherlands	0800 0233200
Russia	8800 5009286
Spain	0800 000154
Sweden	0200 882255
Switzerland	0800 805353
	Opt. 1 (DE)
	Opt. 2 (FR)
	Opt. 3 (IT)
United Kingdom	0800 0260637

For other unlisted countries:
www.keysight.com/find/contactus
 (BP-07-10-14)